

Transistors

# Switching (200V, 10A)

## RDN100N20

●Features

- 1) Low on-resistance.
- 2) Low input capacitance.
- 3) Excellent resistance to damage from static electricity.

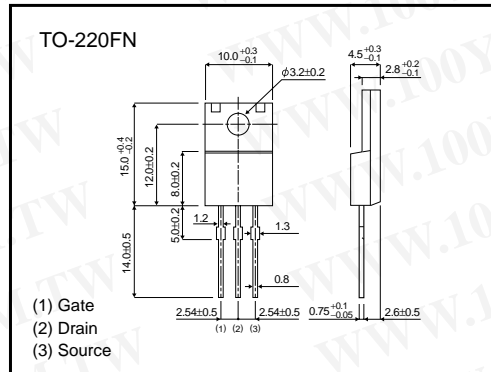
●Application

Switching

●Structure

Silicon N-channel  
 MOS FET

●External dimensions (Unit : mm)



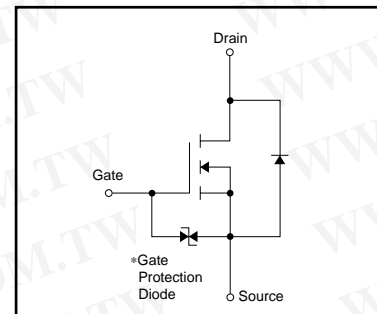
●Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit
Drain-Source Voltage	$V_{DS}$	200	V
Gate-Source Voltage	$V_{GS}$	±30	V
Drain Current	Continuous	$I_D$	10 A
	Pulsed	$I_{DP}$ *1	40 A
Reverse Drain Current	Continuous	$I_{DR}$	10 A
	Pulsed	$I_{DRP}$ *1	40 A
Avalanche Current	$I_{AS}$ *2	10	A
Avalanche Energy	$E_{AS}$ *2	120	mJ
Total Power Dissipation (Tc=25°C)	$P_D$	35	W
Channel Temperature	$T_{ch}$	150	°C
Storage Temperature	$T_{sig}$	-55 to +150	°C

\*1  $P_w \leq 10\mu s$ , Duty cycle  $\leq 1\%$

\*2  $L = 4.5mH$ ,  $V_{DD} = 50V$ ,  $R_G = 25\Omega$ , 1Pulse,  $T_{ch} = 25^\circ C$

●Equivalent circuit



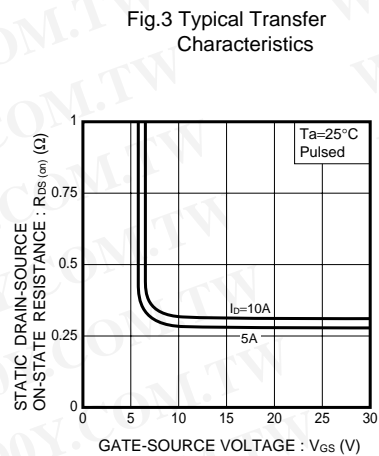
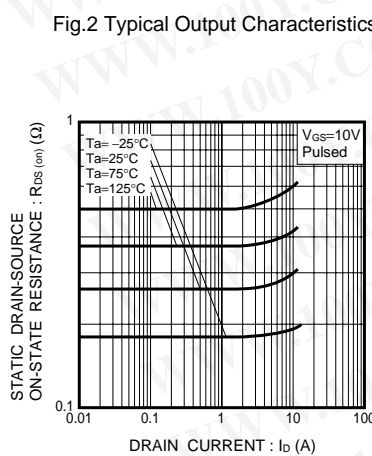
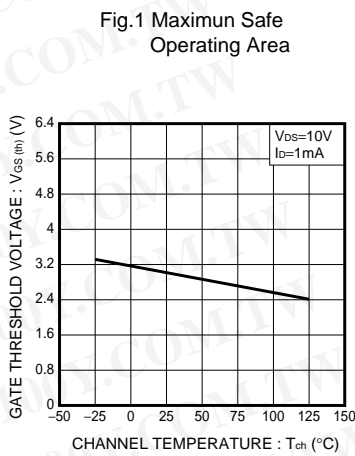
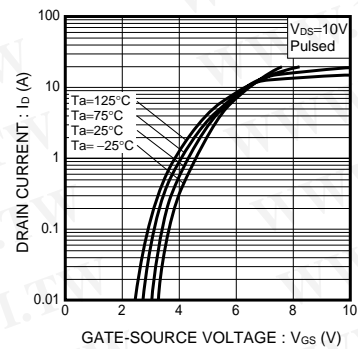
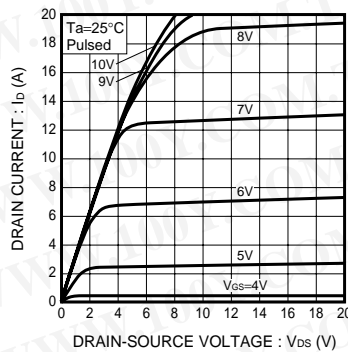
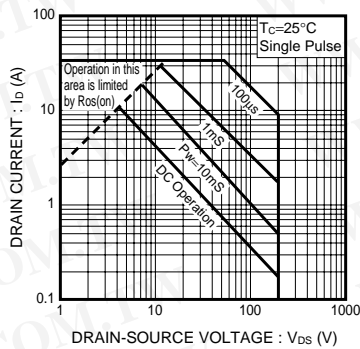
\*A protection diode is included between the gate and the source terminals to protect the diode against static electricity when the product is in use. Use the protection circuit when the fixed voltages are exceeded.

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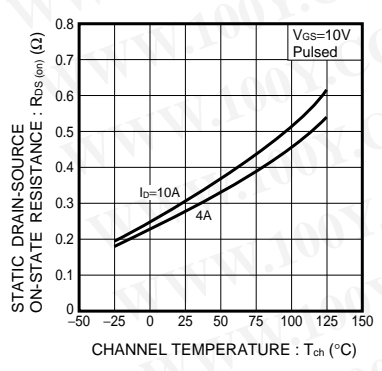
●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-Source Leakage	$I_{GSS}$	—	—	±10	μA	$V_{GS}=\pm 30V, V_{DS}=0V$
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	200	—	—	V	$I_D=250\mu A, V_{GS}=0V$
Zero Gate Voltage Drain Current	$I_{DSS}$	—	—	25	μA	$V_{DS}=200V, V_{GS}=0V$
Gate Threshold Voltage	$V_{GS(th)}$	2.0	—	4.0	V	$V_{DS}=10V, I_D=1mA$
Static Drain-Source On-State Resistance	$R_{DS(on)}$	—	0.27	0.36	Ω	$I_D=5A, V_{GS}=10V$
Forward Transfer Admittance	$ Y_{fs} $	2.3	3.8	—	S	$V_{DS}=10V, I_D=5A$
Input Capacitance	$C_{iss}$	—	543	—	pF	$V_{DS}=10V$
Output Capacitance	$C_{oss}$	—	193	—	pF	$V_{GS}=0V$
Reverse Transfer Capacitance	$C_{rss}$	—	64	—	pF	$f=1MHz$
Turn-On Delay Time	$t_{d(on)}$	—	13	—	ns	$I_D=5A, V_{DD} \approx 100V$
Rise Time	$t_r$	—	29	—	ns	$V_{GS}=10V$
Turn-Off Delay Time	$t_{d(off)}$	—	38	—	ns	$R_L=20\Omega$
Fall Time	$t_f$	—	26	—	ns	$R_{GS}=10\Omega$
Reverse Recovery Time	$t_{rr}$	—	133	—	ns	$I_{DR}=10A, V_{GS}=0V$
Reverse Recovery Charge	$Q_{rr}$	—	0.54	—	μC	$di/dt=100A/\mu s$
Total Gate Charge	$Q_g$	—	15	—	nC	$V_{DD}=100V, V_{GS}=10V, I_D=10A$

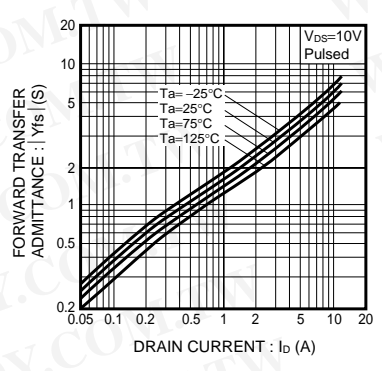
●Electrical characteristic curves



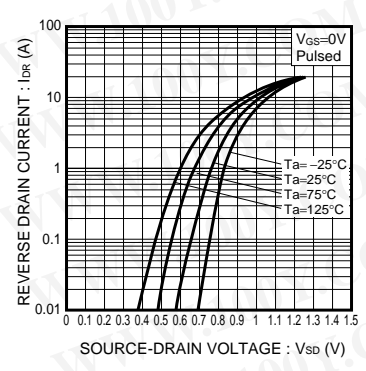
**Transistors**



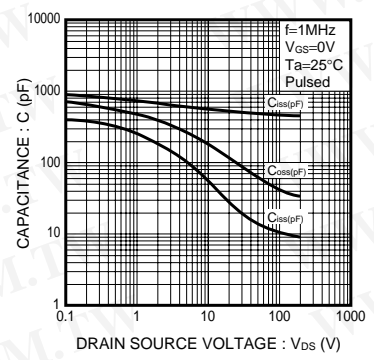
**Fig.7 Static Drain-Source On-State Resistance vs. Channel Temperature**



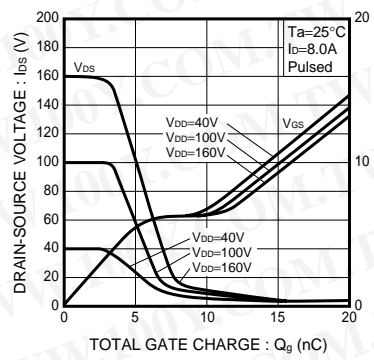
**Fig.8 Forward Transfer Admittance vs. Drain Current**



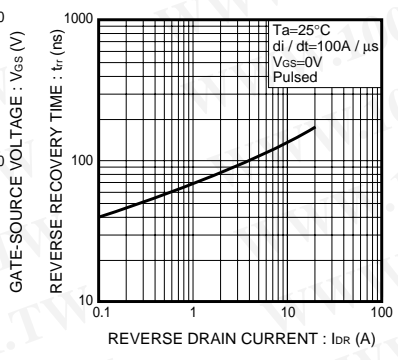
**Fig.9 Reverse Drain Current vs. Source-Drain Voltage**



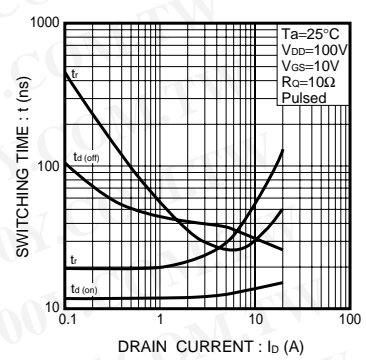
**Fig.10 Typical Capacitance vs. Drain-Source Voltage**



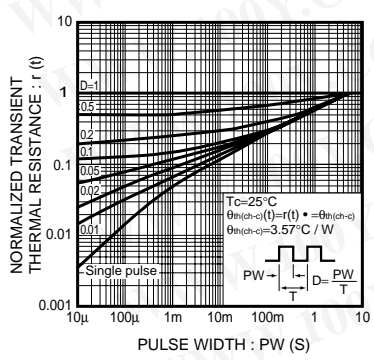
**Fig.11 Dynamic Input Characteristics**



**Fig.12 Reverse Recovery Time vs. Reverse Drain Current**



**Fig.13 Switching Characteristics**



**Fig.14 Normalized Transient Thermal Resistance vs. Pulse Width**

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